# Miramid® FP10KSC

### Polyamide 6

#### BASF Leuna GmbH

#### Message:

 $Miramid \, \$ \, \, FP10KSC \, is \, a \, Polyamide \, 6 \, (Nylon \, 6) \, \, material. \, It \, is \, available \, in \, Europe \, for \, injection \, molding.$ 

Important attributes of Miramid® FP10KSC are:

Chemical Resistant

Crystalline

Fast Molding Cycle

Impact Resistant

Mold Release Agent

Typical applications include:

Engineering/Industrial Parts

Automotive

**Construction Applications** 

Electrical/Electronic Applications

Furniture

General Information					
Additive		Mold Release			
Features		Crystalline			
		Fast Molding Cycle			
		Fuel Resistant			
		Good Flow			
		Good Impact Resistance			
		Grease Resistant			
		Oil Resistant			
		Solvent Resistant			
Uses		Automotive Applications			
		Building Materials			
		Electrical Parts			
		Fasteners			
		Fittings			
		Furniture			
		Housings			
		Plugs			
Forms		Granules			
Processing Method		Injection Molding			
Multi-Point Data		Isothermal Stress vs. Strain (ISO 11403-1)			
		Secant Modulus vs. Strain (ISO 11403-1)			
Physical	Dry	Conditioned	Unit	Test Method	

Density	1120		kg/m³	ISO 1183 <sup>1</sup>
Water Absorption			<u> </u>	ISO 62 <sup>2</sup>
Saturation	8.5	<del></del>	%	
Equilibrium	2.8		%	
Mechanical	Dry	Conditioned	Unit	Test Method
Tensile modulus	2700	1000	MPa	ISO 527-2 <sup>3</sup>
Tensile Stress (Yield)	70.0	40.0	MPa	ISO 527-2 <sup>4</sup>
Tensile Strain (Yield)	4.0	20	%	ISO 527-2 <sup>5</sup>
Nominal Tensile Strain at Break	10	> 50	%	ISO 527-2
Impact	Dry	Conditioned	Unit	Test Method
Charpy notched impact strength				ISO 179/1eA <sup>6</sup>
-30°C	6.00		kJ/m²	
23°C	8.00	30.0	kJ/m²	
Charpy impact strength				ISO 179/1eU <sup>7</sup>
-30°C	No Break			
23°C	No Break	No Break		
Thermal	Dry	Conditioned	Unit	Test Method
Deflection Temperature Under Load				ISO 75-2 <sup>8</sup>
0.45 MPa	180		°C	
1.8 MPa	60.0		°C	
Melting Temperature (DSC)	220		°C	ISO 3146
Electrical	Dry	Conditioned	Unit	Test Method
Volume resistivity	1.0E+13	1.0E+10	ohms·m	IEC 60093 <sup>9</sup>
Dielectric Constant (1 MHz)	3.40	6.00		IEC 60250
Dissipation Factor (1 MHz)	0.015	0.25		IEC 60250 <sup>10</sup>
Comparative tracking index	600			IEC 60112 <sup>11</sup>
Injection	Dry	Unit		
Processing (Melt) Temp	240 to 260		°C	
Mold Temperature	40.0 to 80.0		°C	
NOTE				
1.	Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.			
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11.	unless otherwise noted.

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#### Recommended distributors for this material

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